

# P-Channel 20-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY							
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a</sup>	$Q_g$				
	$0.094 \text{ at V}_{GS} = -4.5 \text{ V}$	- 4.5					
- 20	0.131 at V <sub>GS</sub> = - 2.5 V	- 4.5	4.9 nC				
	0.185 at V <sub>GS</sub> = - 1.8 V	- 4.5					

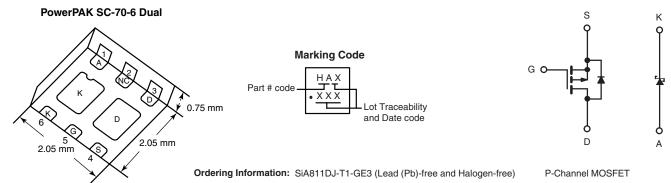
SCHOTTKY PRODUCT SUMMARY					
V <sub>KA</sub> (V)	V <sub>f</sub> (V)  V <sub>KA</sub> (V)  Diode Forward Voltage				
20	0.45 at 1 A	2			

#### **FEATURES**

- · Halogen-free
- LITTLE FOOT<sup>®</sup> Plus Schottky Power MOSFET
- New Thermally Enhanced PowerPAK<sup>®</sup> SC-70 Package
  - Small Footprint Area
  - Low On-Resistance
  - Thin 0.75 mm profile

#### **APPLICATIONS**

- · Cellular Charger Switch
- Asynchronous DC/DC for Portable Devices
- · Load Switch for Portable Devices



Parameter	Symbol	Limit	Unit	
Drain-Source Voltage (MOSFET)		V <sub>DS</sub>	- 20	v
Reverse Voltage (Schottky)		V <sub>KA</sub>	20	
Gate-Source Voltage (MOSFET)		$V_{GS}$	± 8	
	T <sub>C</sub> = 25 °C		- 4.5 <sup>a</sup>	
Continuous Drain Current /T 150 °C) (MOSEET)	T <sub>C</sub> = 70 °C		- 4.5 <sup>a</sup>	
Continuous Drain Current (T <sub>J</sub> = 150 °C) (MOSFET)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 3.6 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		- 2.9 <sup>b, c</sup>	
Pulsed Drain Current (MOSFET)	I <sub>DM</sub>	- 8	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		- 4.5 <sup>a</sup>	
(MOSFET Diode Conduction)	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 1.6 <sup>b, c</sup>	
Average Forward Current (Schottky)		I <sub>F</sub>	2 <sup>b</sup>	
Pulsed Forward Current (Schottky)	I <sub>FM</sub>	5		
	T <sub>C</sub> = 25 °C		6.5	
Maximum Daylor Dissipation (MOCFFT)	T <sub>C</sub> = 70 °C		5	
Maximum Power Dissipation (MOSFET)	T <sub>A</sub> = 25 °C		1.9 <sup>b, c</sup>	7
	T <sub>A</sub> = 70 °C	P <sub>D</sub>	1.2 <sup>b, c</sup>	W
	T <sub>C</sub> = 25 °C	L D	6.8	vv
Maximum Dayer Dissipation (Cabattley)	T <sub>C</sub> = 70 °C		4.3	
Maximum Power Dissipation (Schottky)	T <sub>A</sub> = 25 °C		1.6 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		1.0 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260	

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THERMAL RESISTANCE RATINGS									
Parameter	Symbol	Typical	Maximum	Unit					
Maximum Junction-to-Ambient (MOSFET) <sup>b, f</sup>	t ≤ 5 s	$R_{thJA}$	52	65					
Maximum Junction-to-Case (Drain) (MOSFET)	Steady State	$R_{thJC}$	12.5	16	°C/W				
Maximum Junction-to-Ambient (Schottky) <sup>b, f</sup>	t ≤ 5 s	R <sub>thJA</sub>	62	76	C/VV				
Maximum Junction-to-Case (Drain) (Schottky)	Steady State	R <sub>thJC</sub>	15	18.5					

#### Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 110 °C/W.

<b>SPECIFICATIONS</b> $T_J = 25$ °	C, unless oth	erwise noted					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 16.2		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_{J}$	η = 200 μΑ		2.1			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.4		- 1	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current	l	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1	μА	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 8			Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -2.8 \text{ A}$		0.078	0.094		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 2.3 A		0.109	0.131	Ω	
		$V_{GS} = -1.8 \text{ V}, I_D = -0.54 \text{ A}$		0.153	0.185		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 2.8 A		7		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			355			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		75		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			50			
Total Gate Charge	Qg	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -4.5 \text{ A}$		8.5	13	nC	
Total Gate Charge				4.9	7.4		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -4.5 \text{ A}$		0.75		IIC IIC	
Gate-Drain Charge	$Q_{gd}$			1.2			
Gate Resistance	$R_g$	f = 1 MHz		8		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			10	15		
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_{L} = 2.2 \Omega$		35	55		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 4.5 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		40	60		
Fall Time	t <sub>f</sub>			50	75	ne	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_{L} = 2.2 \Omega$		10	15		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -4.5 \text{ A}, V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$		20	30		
Fall Time	t <sub>f</sub>			10	15	1	

#### **New Product**



# SiA811DJ

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SPECIFICATIONS T <sub>J</sub> = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.5	Α		
Pulse Diode Forward Current	I <sub>SM</sub>				- 8	A		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 4.5 A, V <sub>GS</sub> = 0 V		- 0.85	- 1.2	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>			30	60	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 4.5 A, di/dt = 100 A/μs, T <sub>.1</sub> = 25 °C		13	26	nC		
Reverse Recovery Fall Time	t <sub>a</sub>	1		10		ns		
Reverse Recovery Rise Time	t <sub>b</sub>			15		113		

#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

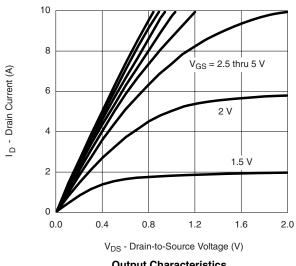
SCHOTTKY SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Forward Voltage Drop	V <sub>F</sub>	I <sub>F</sub> = 1 A		0.41	0.45	V		
		I <sub>F</sub> = 1 A, T <sub>J</sub> = 125 °C		0.36	0.41			
		V <sub>r</sub> = 5 V		0.015	0.08	-		
		V <sub>r</sub> = 5 V, T <sub>J</sub> = 85 °C		0.5	5.0			
Maximum Reverse Leakage Current	I <sub>rm</sub>	$I_{rm}$ $V_r = 20 \text{ V}$ 0.02 $V_r = 20 \text{ V}, T_J = 85 \text{ °C}$ 0.7	0.02	0.10	mA			
			0.7	7				
		V <sub>r</sub> = 20 V, T <sub>J</sub> = 125 °C		5	50	1		
Junction Capacitance	C <sub>T</sub>	V <sub>r</sub> = 10 V		60		pF		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

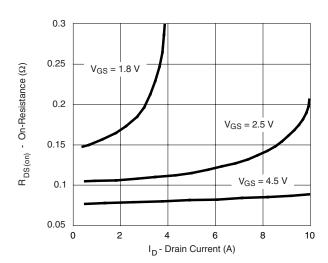
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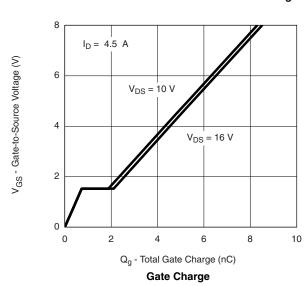
## **MOSFET TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted

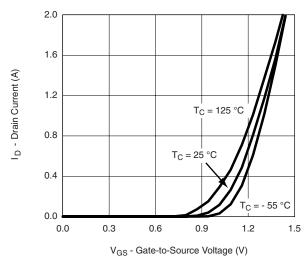


## **Output Characteristics**

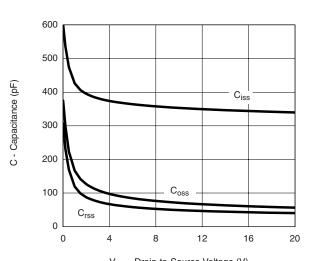


#### On-Resistance vs. Drain Current and Gate Voltage

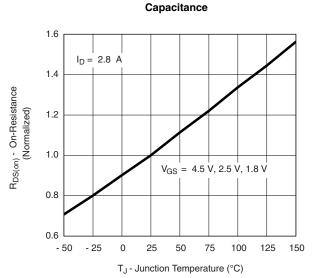




**Transfer Characteristics** 



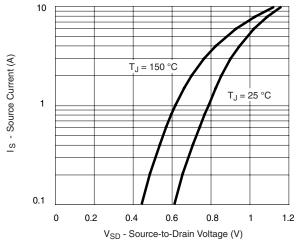
V<sub>DS</sub> - Drain-to-Source Voltage (V)



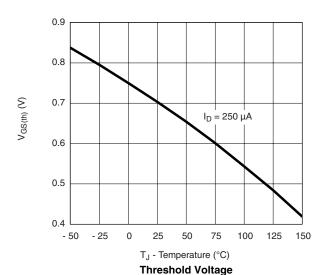
On-Resistance vs. Junction Temperature

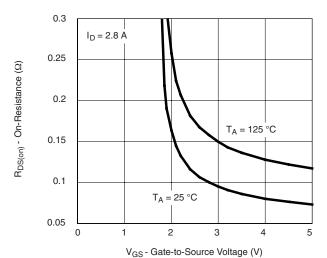


## **MOSFET TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted

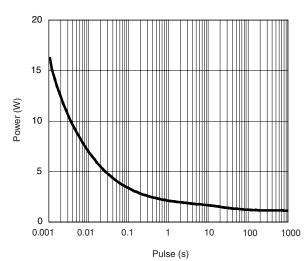


#### Soure-Drain Diode Forward Voltage

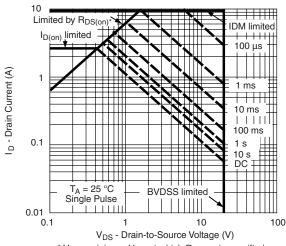




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



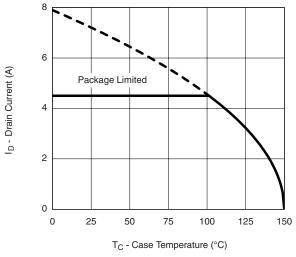
 $^{\star}$   $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

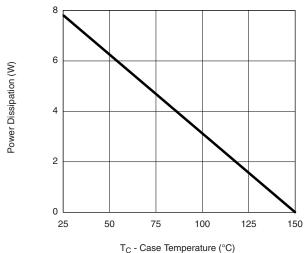
Safe Operating Area, Junction-to-Case

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## **MOSFET TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted





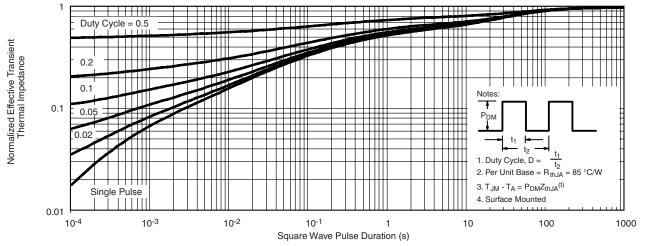
Power Derating

Current Derating\*

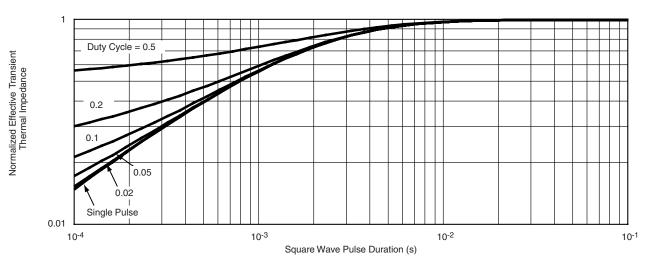
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



## **MOSFET TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient

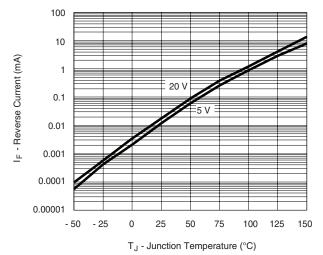


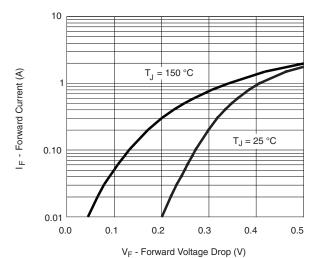
Normalized Thermal Transient Impedance, Junction-to-Case

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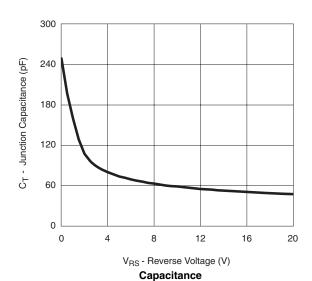
## SCHOTTKY TYPICAL CHARACTERISTICS $T_A = 25~^{\circ}C$ , unless otherwise noted





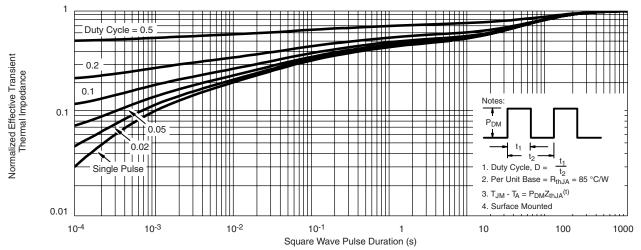
**Reverse Current vs. Junction Temperature** 

Forward Voltage Drop

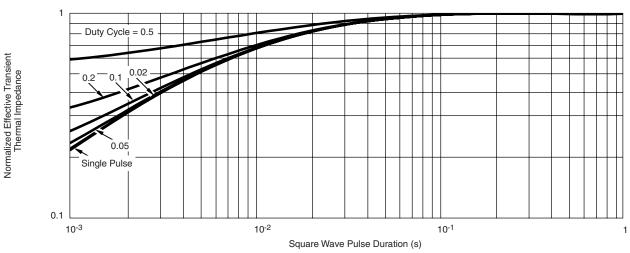




## **SCHOTTKY TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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